

2N/PN3567 • 2N/PN3568 • 2N/PN3569

NPN SMALL SIGNAL GENERAL PURPOSE AMPLIFIERS

DIFFUSED SILICON PLANAR* EPITAXIAL TRANSISTORS

ABSOLUTE MAXIMUM RATINGS (Note 1)

	2N3567/8/9	PN3567/8/9
Maximum Temperatures		
Storage Temperature	-55°C to +125°C	-55°C to +150°C
Operating Junction Temperature	125°C	150°C
Lead Temperature (10 seconds)	260°C	260°C
Maximum Power Dissipation (Notes 2 & 3)		
Total Dissipation at 25°C Case Temperature	0.8 W	1.0 W
at 25°C Ambient Temperature	0.3 W	0.625 W
Maximum Voltages and Currents	2N/PN3568	2N/PN3567/9
V _{EB0} Emitter to Base Voltage	5.0 V	5.0 V
V _{CB0} Collector to Base Voltage	80 V	80 V
V _{CEO} Collector to Emitter Voltage (Notes 4 & 6)	60 V	40 V
I _C Collector Current	500 mA	500 mA
I _B Base Current	100 mA	100 mA

ELECTRICAL CHARACTERISTICS (25°C Ambient Temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N/PN3567		2N/PN3568		2N/PN3569		UNITS	TEST CONDITIONS
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
I _{CBO}	Collector Cutoff Current		50	50		50		nA	V _{CB} = 40 V, I _E = 0
I _{EBO}	Emitter Cutoff Current		5.0	5.0		5.0		μA	V _{CB} = 40 V, I _E = 0, T _A = 75°C
BV _{CB0}	Collector to Base Breakdown Voltage	80		80		80		V	V _{EB} = 4.0 V, I _C = 0
BV _{EBO}	Emitter to Base Breakdown Voltage	5.0		5.0		5.0		V	I _E = 0, I _C = 100 μA
BV _{CEO}	Collector to Emitter Breakdown Voltage (Note 5)	40		60		40		V	I _B = 0, I _C = 30 mA
h _{FE}	DC Current Gain (Note 5)	40	120	40	120	100	300		V _{CE} = 1.0 V, I _C = 150 mA
V _{BE(ON)}	Base to Emitter "On" Voltage (Note 5)		1.1		1.1		1.1	V	V _{CE} = 1.0 V, I _C = 150 mA
V _{CE(sat)}	Collector to Emitter Saturation Voltage (Note 5)		0.25		0.25		0.25	V	I _C = 150 mA, I _B = 15 mA
C _{cb}	Collector to Base Capacitance		20		20		20	pF	I _E = 0, V _{CB} = 10 V, f = 140 kHz
C _{eb}	Emitter to Base Capacitance		80		80		80	pF	I _C = 0, V _{EB} = 0.5 V, f = 140 kHz
h _{fe1}	Magnitude of Common Emitter Small Signal Current Gain	3.0	30	3.0	30	3.0	30		V _{CE} = 10 V, I _C = 50 mA f = 20 MHz

NOTES:

1. These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
3. These ratings give a maximum junction temperature of 125°C and junction to case thermal resistance of 125°C/W (derating factor of 8.0 mW/°C); junction to ambient thermal resistance of 333°C/W (derating factor of 3.0 mW/°C) for 2N3567, 2N3568, and 2N3569. These ratings give a maximum junction temperature of 150°C/W and junction to case thermal resistance of 125°C/W (derating factor of 8.0 mW/°C); junction to ambient thermal resistance of 200°C/W (derating factor of 5.0 mW/°C) for PN3567, PN3568, and PN3569.
4. This rating refers to a high current point where collector to emitter voltage is lowest.
5. Pulse Conditions: length = 300 μs; duty cycle = 1%.
6. Applicable 0 to 30 mA.